

Description

The SiT9375 is a differential MEMS oscillator that is engineered for low-jitter applications requiring standard frequencies from 25 MHz to 644.53125 MHz.

A unique FlexSwing output-driver performs like LVPECL but provides independent control of voltage swing and DC offset to simplify interfacing with chipsets having non-standard input voltage requirements and eliminate all external source-bias resistors. The device also integrates multiple on-chip regulators to filter power supply noise, eliminating the need for an external dedicated LDO.

The SiT9375 can be factory programmed for specific combinations of frequency, stability, voltage, output signaling, and pin 1 functionality. Programmability enables designers to optimize clock configurations while eliminating long lead times and customization costs associated with quartz devices where each combination is custom built.

The wide frequency range and programmability makes this device ideal for communications, enterprise, and industrial applications that require a variety of frequencies and operate in noisy environments.

Refer to [Manufacturing Notes](#) for proper reflow profile, tape and reel dimension, and other manufacturing related information.

Features

- Standard frequencies from 25 MHz to 644.53125 MHz
- 200 fs RMS typical phase jitter, 12 kHz to 20 MHz
- Excellent power-supply noise rejection
- LVPECL, LVDS, HCSL, Low-power HCSL, and FlexSwing signaling options
- ± 20 , ± 25 , ± 30 , and ± 50 ppm frequency stabilities
- Wide temperature support up to -40°C to 105°C
- Factory programmable options for low lead time
- 1.8 V, 2.5 V, 3.3 V, and wide continuous range power supply voltage
- 2 x 1.6, 2.5 x 2, 3.2 x 2.5 mm x mm package ([Contact SiTime](#) for 7 x 5, and 5 x 3.2 mm x mm packages)

Applications

- 100G/200G/400G network equipment
- Optical modules
- Coherent optics
- Network switches, routers
- Industrial networking equipment
- Server and storage systems
- Industrial networks
- Test and measurement
- Broadcast video

Block Diagram

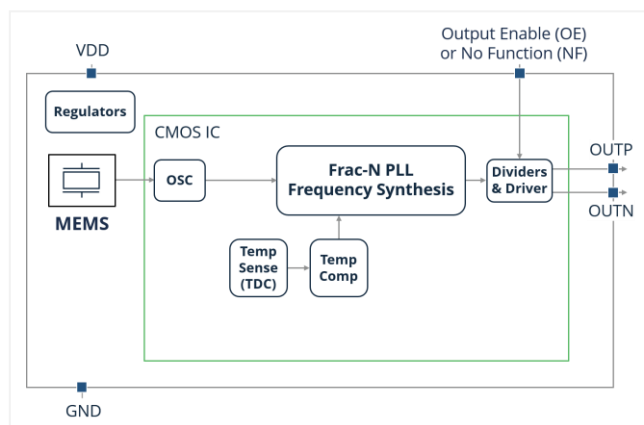


Figure 1. SiT9375 Block Diagram

Package Pinout

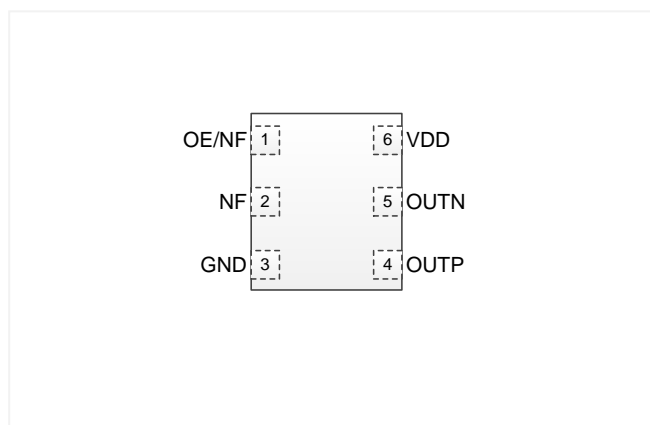


Figure 2. Pin Assignments (Top view)
(Refer to [Table 17](#) for Pin Descriptions)

Ordering Information

SiT9375AC-01B2-3310-125.000000T

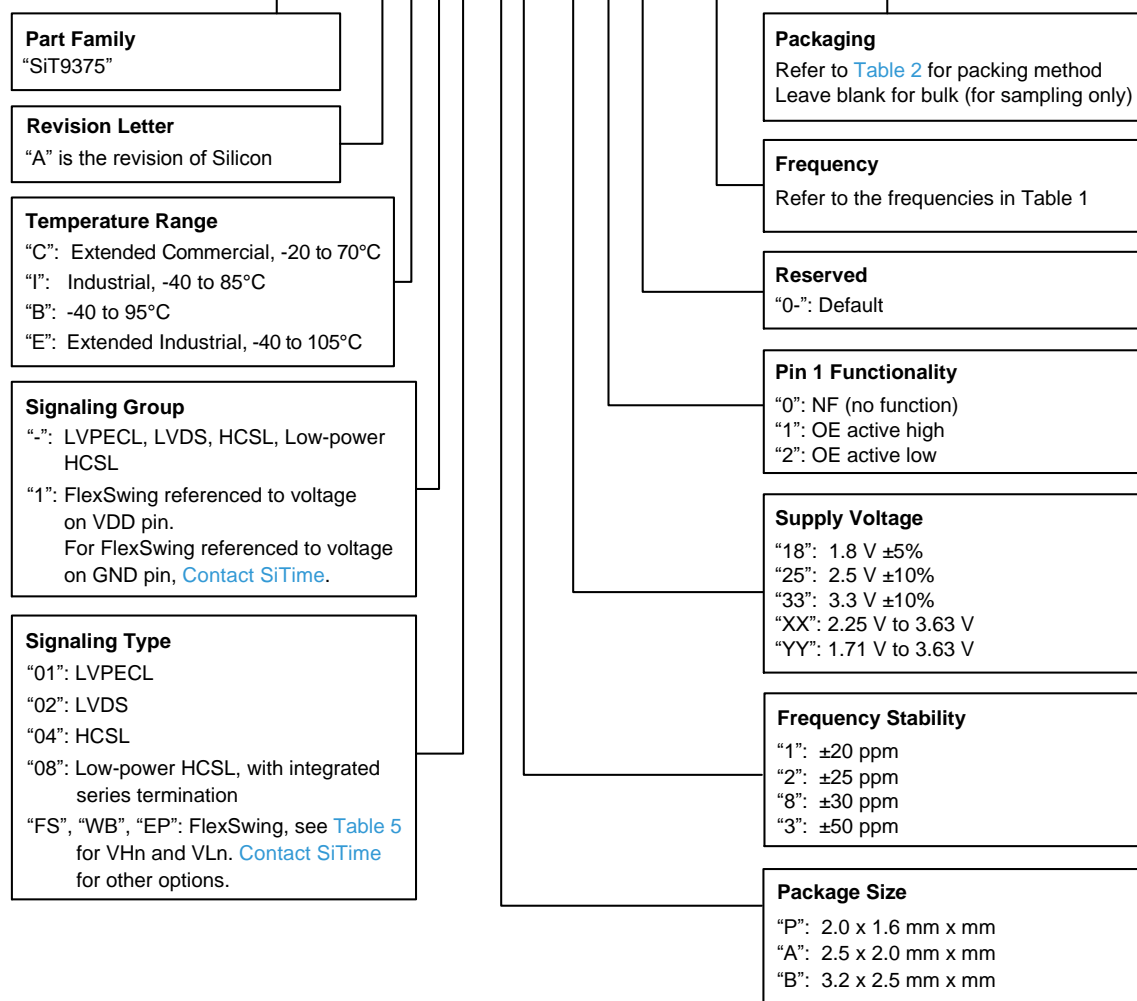


Table 1. Supported Frequencies

25.000000 MHz	30.720000 MHz	50.000000 MHz	53.125000 MHz	61.440000 MHz	62.500000 MHz	74.250000 MHz	75.000000 MHz
98.304000 MHz	100.000000 MHz	106.250000 MHz	122.880000 MHz	125.000000 MHz	133.333333 MHz	148.500000 MHz	150.000000 MHz
153.600000 MHz	155.520000 MHz	156.250000 MHz	159.375000 MHz	160.000000 MHz	161.132813 MHz	166.666666 MHz	200.000000 MHz
212.500000 MHz	250.000000 MHz	300.000000 MHz	312.500000 MHz	322.265625 MHz	625.000000 MHz	644.531250 MHz	

Table 2. Ordering Codes for Supported Tape & Reel Packing Method

Device Size (mm x mm)	8 mm T&R (3ku)	8 mm T&R (1ku)	8 mm T&R (250u)
2.0 x 1.6	D	E	G
2.5 x 2.0	D	E	G
3.2 x 2.5	D	E	G

TABLE OF CONTENTS

Description	1
Features	1
Applications	1
Block Diagram	1
Package Pinout	1
Ordering Information	2
Electrical Characteristics	4
Pin Description	12
FlexSwing Configurations	13
Waveform Diagrams	15
Termination Diagrams	18
LVPECL and FlexSwing Termination	18
LVDS, Supply Voltage: 1.8 V \pm 5%, 2.5 V \pm 10%, 3.3 V \pm 10%, 2.25 V to 3.63 V, 1.71 V to 3.63 V	19
HCSL, Supply Voltage: 1.8 V \pm 5%, 2.5 V \pm 10%, 3.3 V \pm 10%, 2.25 V to 3.63 V, 1.71 V to 3.63 V	19
Low-power HCSL, Supply Voltage: 1.8 V \pm 5%, 2.5 V \pm 10%, 3.3 V \pm 10%, 2.25 V to 3.63 V, 1.71 V to 3.63 V	19
Dimensions and Patterns — 2.0 x 1.6 mm x mm	20
Dimensions and Patterns — 2.5 x 2.0 mm x mm	21
Dimensions and Patterns — 3.2 x 2.0 mm x mm	22
Additional Information	23
Revision History	23

Electrical Characteristics

All Min and Max limits in the Electrical Characteristics tables are specified over operating temperature and rated operating voltage with standard output termination shown in the termination diagrams. Typical values are at 25°C and nominal supply voltage.

Table 3. Electrical Characteristics – Common to All Output Signaling Types

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Frequency Range						
Output Frequency Range	f	Standard frequencies			MHz	Refer to frequencies listed in Ordering Information section.
Frequency Stability						
Frequency Stability	F_stab	–	–	±20	ppm	Inclusive of initial tolerance, operating temperature, rated power supply voltage, load variation of 15 pF ± 10%, and 10 years aging at 25°C
		–	–	±25	ppm	Inclusive of initial tolerance, operating temperature, rated power supply voltage, load variation of 15 pF ± 10%, and first year aging at 25°C
		–	–	±30	ppm	
		–	–	±50	ppm	
10 Year Aging	F_10y	–	±1	–	ppm	Ambient temperature of 25°C
Temperature Range						
Operating TemperatureRange	T_use	-20	–	+70	°C	Extended commercial, ambient temperature
		-40	–	+85	°C	Industrial, ambient temperature
		-40	–	+95	°C	Ambient temperature
		-40	–	+105	°C	Extended industrial, ambient temperature
Supply Voltage						
Supply Voltage	Vdd	1.71	–	3.63	V	Voltage-supply order code “YY”
		2.25	–	3.63	V	Voltage-supply order code “XX”
		1.71	1.80	1.89	V	Voltage-supply order code “18”. Contact SiTime for 1.5 V
		2.25	2.50	2.75	V	Voltage-supply order code “25”
		2.97	3.30	3.63	V	Voltage-supply order code “33”
Input Characteristics						
Input Voltage High	VIH	70%	–	–	Vdd	Pins 1 and 2 for OE and SE, respectively
Input Voltage Low	VIL	–	–	30%	Vdd	Pins 1 and 2 for OE and SE, respectively
Input Pull-up Impedance	Z_in	–	100	–	kΩ	Pins 1 and 2 for OE and SE, respectively
Output Characteristics						
Duty Cycle	DC	45	–	55	%	See Figure 5 and Figure 7
Startup, OE and SE Timing						
Startup Time	T_start	–	1	5	ms	Measured from the time Vdd reaches its rated minimum value
Output Enable Time	T_oe	–	–	100+3 clock cycles	ns	Measured from the time OE pin toggles to enable logic level to the time clock pins reach 90% of swing. See Figure 12
Output Disable Time	T_od	–	–	100+3 clock cycles	ns	Measured from the time OE pin toggles to disable logic level to the last clock edge. See Figure 13
Jitter and Phase Noise						
RMS Phase Jitter (random)	T_phj	–	170	–	fs	12 kHz to 20 MHz offset frequency integration bandwidth, 156.25 MHz
Spurious Phase Noise	PN_spur_a	–	-110	–	dBc	12 kHz to 20 MHz offset frequency range, 156.25 MHz
	PN_spur_b	–	-80	–	dBc	12 kHz to 20 MHz offset frequency range, 155.52 MHz
RMS Period Jitter ^[1]	T_jitt_per	–	1	–	ps	156.25 MHz
Peak Cycle-to-cycle Jitter ^[1]	T_jitt_cc	–	6	–	ps	156.25 MHz

Note:

1. Measured according to JESD65B.

Table 4. Electrical Characteristics – LVPECL | Supply voltages: 2.5 V $\pm 10\%$, 3.3 V $\pm 10\%$, 2.25 V to 3.63 V

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Current Consumption, f = 156.25 MHz						
Current Consumption, Output Enabled without Termination	Idd_oe_nt	–	43	–	mA	Excluding load termination current
Current Consumption, Output Enabled with Termination 1	Idd_oe_wt1	–	56	–	mA	Including load termination current as shown in Figure 17 for Vdd=3.3 V $\pm 10\%$, Vdd=2.25 V to 3.63 V, and R3=220 Ohms.
		–	54.5	–	mA	Including load termination current as shown in Figure 17 for Vdd=2.5 V $\pm 10\%$ and R3=220 Ohms.
Current Consumption, Output Enabled with Termination 2	Idd_oe_wt2	–	71	–	mA	Including load termination current. See Figure 18 for termination
Current Consumption, Output Disabled without Termination	Idd_od_nt	–	52	–	mA	Excluding load termination current. Driver output is at logic-high voltage levels.
Current Consumption Output Disabled with Termination 1	Idd_od_wt1	–	65	–	mA	Including load termination current as shown in Figure 17 for Vdd=3.3 V $\pm 10\%$, Vdd=2.25 V to 3.63 V, and R3=220 Ohms. Driver output is at logic-high voltage levels.
		–	63.5	–	mA	Including load termination current as shown in Figure 17 for Vdd=2.5 V $\pm 10\%$ and R3=220 Ohms.
Current Consumption, Output Disabled with Termination 2	Idd_od_wt2	–	80	–	mA	Including load termination current. See Figure 18 for termination. Driver output is at logic-high voltage levels.
Output Characteristics						
Output High Voltage	VOH	Vdd-1.025	Vdd-0.95	Vdd-0.88	V	See Figure 4
Output Low Voltage	VOL	Vdd-1.81	Vdd-1.7	Vdd-1.62	V	See Figure 4
Output Differential Voltage Swing	V_Swing	1.2	1.5	1.9	V	See Figure 5
Rise/Fall Time	Tr, Tf	–	170	–	ps	20% to 80%. See Figure 5
Differential Asymmetry, peak-peak	V_da	–	100	–	mV	See Figure 8
Differential Skew, peak	V_ds	–	± 40	–	ps	See Figure 9
Overshoot Voltage, peak	V_ov	–	10	–	%	Measured as percent of V_Swing; see Figure 10
Power Supply Noise Immunity						
Power Supply-Induced Jitter Sensitivity ^[2]	PSJS	–	0.01	–	ps/mV	Power supply ripple from 1 kHz to 20 MHz
Power Supply-Induced Phase Noise	PSPN	–	-80	–	dBc	156.25 MHz, 50 mV peak-peak ripple on VDD

Table 5. Electrical Characteristics – FlexSwing | Supply voltage: 2.5 V \pm 10%, 3.3 V \pm 10%, 2.25 V to 3.63 V

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Current Consumption, f = 156.25 MHz						
Current Consumption, Output Enabled without Termination	Idd_oe_nt	–	43	–	mA	Excluding load termination current
Current Consumption, Output Enabled with Termination	Idd_oe_wt	–	50.5	–	mA	Including load termination current, for FlexSwing order code "WB". See Figure 17 for Vdd=3.3 V ±10%, Vdd=2.25 V to 3.63 V and R3=220 Ohms.
		–	49	–	mA	Including load termination current, for FlexSwing order code "WB". See Figure 17 for Vdd=2.5 V ±10% and R3=220 Ohms.
Current Consumption, Output Disabled without Termination	Idd_od_nt	–	52	–	mA	Excluding load termination current. Driver output is at logic-high voltage levels.
Current Consumption Output Disabled with Termination	Idd_od_wt	–	59.5	–	mA	Including load termination current, for FlexSwing order code "WB". See Figure 17 for Vdd=3.3 V ±10%, Vdd=2.25 V to 3.63 V and R3=220 Ohms.
		–	58	–	mA	Including load termination current, for FlexSwing order code "WB". See Figure 17 for Vdd=2.5 V ±10% and R3=220 Ohms.
Output Characteristics						
Output High Voltage	VOH	VHn - 0.1	VHn	VHn + 0.1	V	See Figure 4 , Refer to Table 18 or Table 19 order codes for nominal VOH (i.e. VHn) values.
Output Low Voltage	VOL	VLn - 0.1	VLn	VLn + 0.1	V	See Figure 4 , Refer to Table 18 or Table 19 order codes for nominal VOL (i.e. VLn) values
Output Differential Voltage Swing	V_Swing	VOH - VOL			V	See Figure 5
Rise/Fall Time	Tr, Tf	–	170	–	ps	20% to 80%. See Figure 5
Differential Asymmetry, peak-peak	V_da	–	100	–	mV	See Figure 8
Differential Skew, peak	V_ds	–	±40	–	ps	See Figure 9
Overshoot Voltage, peak	V_ov	–	10	–	%	Measured as percent of V_Swing; see Figure 10
Power Supply Noise Immunity						
Power Supply-Induced Jitter Sensitivity ^[2]	PSJS	–	0.01	–	ps/mV	Power supply ripple from 1 kHz to 20 MHz
Power Supply-Induced Phase Noise	PSPN	–	-80	–	dBc	156.25 MHz, 50 mV peak-peak ripple on VDD

Table 6. Electrical Characteristics – FlexSwing | Supply voltage referred to GND, only: 1.8 V \pm 5%, 1.71 V to 3.63 V

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Current Consumption, f = 156.25 MHz						
Current Consumption, Output Enabled without Termination	Idd_oe_nt	–	43	–	mA	Excluding load termination current
Current Consumption, Output Enabled with Termination	Idd_oe_wt	–	53	–	mA	Including load termination current, for FlexSwing order code “WB”. See Figure 17 for Vdd=1.8 V ±5% and R3=220 Ohms.
		–	53	–	mA	Including load termination current, for FlexSwing order code “WB”. See Figure 17 for Vdd=1.71 V to 3.63 V and R3=220 Ohms.
Current Consumption, Output Disabled without Termination	Idd_od_nt	–	52	–	mA	Excluding load termination current. Driver output is at logic-high voltage levels.
Current Consumption Output Disabled with Termination	Idd_od_wt	–	62	–	mA	Including load termination current, for FlexSwing order code “WB”. See Figure 17 for Vdd=1.8 V ±5% and R3=220 Ohms.
		–	62	–	mA	Including load termination current, for FlexSwing order code “WB”. See Figure 17 for Vdd=1.71 V to 3.63 V and R3=220 Ohms.
Output Characteristics						
Output High Voltage	VOH	VHn - 0.1	VHn	VHn + 0.1	V	See Figure 4 , Refer to Table 18 or Table 19 order codes for nominal VOH (i.e. VHn) values
Output Low Voltage	VOL	VLn - 0.1	VLn	VLn + 0.1	V	See Figure 4 , Refer to Table 18 or Table 19 order codes for nominal VOL (i.e. VLn) values
Output Differential Voltage Swing	V_Swing	VOH - VOL			V	See Figure 5
Rise/Fall Time	Tr, Tf	–	170	–	ps	20% to 80%. See Figure 5
Differential Asymmetry, peak-peak	V_da	–	100	–	mV	See Figure 8
Differential Skew, peak	V_ds	–	±40	–	ps	See Figure 9
Overshoot Voltage, peak	V_ov	–	10	–	%	Measured as percent of V_Swing; see Figure 10
Power Supply Noise Immunity						
Power Supply-Induced Jitter Sensitivity ^[2]	PSJS	–	0.01	–	ps/mV	Power supply ripple from 1 kHz to 20 MHz
Power Supply-Induced Phase Noise	PSPN	–	-80	–	dBc	156.25 MHz, 50 mV peak-peak ripple on VDD

Table 7. Electrical Characteristics – LVDS | Supply voltage: 2.5 V $\pm 10\%$, 3.3 V $\pm 10\%$, 2.25 V to 3.63 V

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Current Consumption, $f = 156.25$ MHz						
Current Consumption, Output Enabled without Termination	Idd_oe_nt	–	45	–	mA	Excluding load termination current
Current Consumption, Output Enabled with Termination	Idd_oe_wt	–	49	–	mA	Including load termination current. See Figure 21 for termination
Current Consumption, Output Disabled without Termination	Idd_od_nt	–	54	–	mA	Excluding load termination current. Driver output is at logic-high voltage levels.
Current Consumption Output Disabled with Termination	Idd_od_wt	–	58	–	mA	Including load termination current. See Figure 21 for termination. Driver output is at logic-high voltage levels.
Output Characteristics						
Differential Output Voltage	VOD	250	350	450	mV	See Figure 6
Delta VOD	ΔVOD	–	–	50	mV	See Figure 6
Offset Voltage	VOS	1.125	1.2	1.375	V	See Figure 6
Delta VOS	ΔVOS	–	–	50	mV	See Figure 6
Rise/Fall Time	Tr, Tf	–	290	–	ps	Measured with 2 pF capacitive loading to GND, 20% to 80%. See Figure 7
Differential Asymmetry, peak-peak	V_da	–	50	–	mV	See Figure 8
Differential Skew, peak	V_ds	–	± 40	–	ps	See Figure 9
Overshoot Voltage, peak	V_ov	–	10	–	%	Measured as percent of VOD; see Figure 11
Power Supply Noise Immunity						
Power Supply-Induced Jitter Sensitivity ^[2]	PSJS	–	0.01	–	ps/mV	Power supply ripple from 1 kHz to 20 MHz
Power Supply-Induced Phase Noise	PSPN	–	-80	–	dBc	156.25 MHz, 50 mV peak-peak ripple on VDD

Table 8. Electrical Characteristics – LVDS | Supply voltage: 1.8 V $\pm 5\%$, 1.71 V to 3.63 V

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Current Consumption, $f = 156.25$ MHz						
Current Consumption, Output Enabled without Termination	Idd_oe_nt	–	45	–	mA	Excluding load termination current
Current Consumption, Output Enabled with Termination	Idd_oe_wt	–	49	–	mA	Including load termination current. See Figure 21 for termination
Current Consumption, Output Disabled without Termination	Idd_od_nt	–	54	–	mA	Excluding load termination current. Driver output is at logic-high voltage levels.
Current Consumption Output Disabled with Termination	Idd_od_wt	–	58	–	mA	Including load termination current. See Figure 21 for termination. Driver output is at logic-high voltage levels.
Output Characteristics						
Differential Output Voltage	VOD	250	350	450	mV	See Figure 6
Delta VOD	ΔVOD	–	–	50	mV	See Figure 6
Offset Voltage	VOS	1.125	1.2	1.375	V	See Figure 6
Delta VOS	ΔVOS	–	–	50	mV	See Figure 6
Rise/Fall Time	Tr, Tf	–	290	–	ps	Measured with 2 pF capacitive loading to GND, 20% to 80%. See Figure 7
Differential Asymmetry, peak-peak	V_da	–	50	–	mV	See Figure 8
Differential Skew, peak	V_ds	–	± 40	–	ps	See Figure 9
Overshoot Voltage, peak	V_ov	–	10	–	%	Measured as percent of VOD; see Figure 11
Power Supply Noise Immunity						
Power Supply-Induced Jitter Sensitivity ^[2]	PSJS	–	0.01	–	ps/mV	Power supply ripple from 1 kHz to 20 MHz
Power Supply-Induced Phase Noise	PSPN	–	-80	–	dBc	156.25 MHz, 50 mV peak-peak ripple on VDD

Table 9. Electrical Characteristics – HCSL | Supply voltage: 2.5 V \pm 10%, 3.3 V \pm 10%, 2.25 V to 3.63 V

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Current Consumption, f = 156.25 MHz						
Current Consumption, Output Enabled without Termination	Idd_oe_nt	–	41	–	mA	Excluding load termination current
Current Consumption, Output Enabled with Termination	Idd_oe_wt	–	56	–	mA	Including load termination current. See Figure 22 (a) and Figure 22 (b) for termination.
Current Consumption, Output Disabled without Termination	Idd_od_nt	–	49	–	mA	Excluding load termination current. Driver output is at logic-high voltage levels.
Current Consumption, Output Disabled with Termination	Idd_od_wt	–	64	–	mA	Including load termination current. See Figure 22 (a) and Figure 22 (b) for termination. Driver output is at logic-high voltage levels.
Output Characteristics						
Output High Voltage	VOH	0.60	0.7	0.95	V	See Figure 4
Output Low Voltage	VOL	-0.1	0	0.1	V	See Figure 4
Output Differential Voltage Swing	V_Swing	1	1.4	1.6	V	See Figure 5
Rise/Fall Time	Tr, Tf	–	400	–	ps	Measured 20% to 80% using Figure 22 (b) for termination. See Figure 5
Differential Asymmetry, peak-peak	V_da	–	100	–	mV	See Figure 8
Differential Skew, peak	V_ds	–	\pm 40	–	ps	See Figure 9
Overshoot Voltage, peak	V_ov	–	10	–	%	Measured as percent of V_Swing; see Figure 10
Power Supply Noise Immunity						
Power Supply-Induced Jitter Sensitivity ^[2]	PSJS	–	0.01	–	ps/mV	Power supply ripple from 1 kHz to 20 MHz
Power Supply-Induced Phase Noise	PSPN	–	-80	–	dBc	156.25 MHz, 50 mV peak-peak ripple on VDD

Table 10. Electrical Characteristics – HCSL | Supply voltage: 1.8 V \pm 5%, 1.71 V to 3.63 V

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Current Consumption, f = 156.25 MHz						
Current Consumption, Output Enabled without Termination	Idd_oe_nt	–	41	–	mA	Excluding load termination current
Current Consumption, Output Enabled with Termination	Idd_oe_wt	–	56	–	mA	Including load termination current. See Figure 22 (a) and Figure 22 (b) for termination.
Current Consumption, Output Disabled without Termination	Idd_od_nt	–	49	–	mA	Excluding load termination current. Driver output is at logic-high voltage levels.
Current Consumption, Output Disabled with Termination	Idd_od_wt	–	64	–	mA	Including load termination current. See Figure 22 (a) and Figure 22 (b) for termination. Driver output is at logic-high voltage levels.
Output Characteristics						
Output High Voltage	VOH	0.60	0.7	0.95	V	See Figure 4
Output Low Voltage	VOL	-0.1	0	0.1	V	See Figure 4
Output Differential Voltage Swing	V_Swing	1	1.4	1.6	V	See Figure 5
Rise/Fall Time	Tr, Tf	–	400	–	ps	Measured 20% to 80% using Figure 22 (b) for termination. See Figure 5
Differential Asymmetry, peak-peak	V_da	–	100	–	mV	See Figure 8
Differential Skew, peak	V_ds	–	\pm 40	–	ps	See Figure 9
Overshoot Voltage, peak	V_ov	–	10	–	%	Measured as percent of V_Swing; see Figure 10
Power Supply Noise Immunity						
Power Supply-Induced Jitter Sensitivity ^[2]	PSJS	–	0.01	–	ps/mV	Power supply ripple from 1 kHz to 20 MHz
Power Supply-Induced Phase Noise	PSPN	–	-80	–	dBc	156.25 MHz, 50 mV peak-peak ripple on VDD

Table 11. Electrical Characteristics – Low Power HCSL | Supply voltage: 2.5 V \pm 10%, 3.3 V \pm 10%, 2.25 V to 3.63 V

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Current Consumption, f = 156.25 MHz						
Current Consumption, Output Enabled without Termination	Idd_oe_nt	–	44	–	mA	Excluding load termination current
Current Consumption, Output Enabled with Termination	Idd_oe_wt	–	46	–	mA	Including load termination current for 5 pF loading at 156.25 MHz. See Figure 23 for termination
Current Consumption, Output Disabled without Termination	Idd_od_nt	–	48	–	mA	Excluding load termination current. Driver output is at logic-high voltage levels.
Current Consumption, Output Disabled with Termination	Idd_od_wt	–	48	–	mA	Including load termination current for 5 pF loading at 156.25 MHz. See Figure 23 for termination. Driver output is at logic-high voltage levels.
Output Characteristics						
Output High Voltage	VOH	0.8	0.9	1.15	V	See Figure 4
Output Low Voltage	VOL	-0.3	0	0.1	V	See Figure 4
Output Differential Voltage Swing	V_Swing	1.55	1.65	1.9	V	See Figure 5
Rise/Fall Time	Tr, Tf	–	520	–	ps	Measured with 2 pF capacitive loading to GND, 20% to 80%. See Figure 5
Differential Asymmetry, peak-peak	V_da	–	550	–	mV	See Figure 8
Differential Skew, peak	V_ds	–	\pm 30	–	ps	See Figure 9
Overshoot Voltage, peak	V_ov	–	10	–	%	Measured as percent of V_Swing; see Figure 10
Power Supply Noise Immunity						
Power Supply-Induced Jitter Sensitivity ^[2]	PSJS	–	0.01	–	ps/mV	Power supply ripple from 1 kHz to 20 MHz
Power Supply-Induced Phase Noise	PSPN	–	-80	–	dBc	156.25 MHz, 50 mV peak-peak ripple on VDD

Table 12. Electrical Characteristics – Low Power HCSL | Supply voltage: 1.8 V \pm 5%, 1.71 V to 3.63 V

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Current Consumption, f = 156.25 MHz						
Current Consumption, Output Enabled without Termination	Idd_oe_nt	–	44	–	mA	Excluding load termination current
Current Consumption, Output Enabled with Termination	Idd_oe_wt	–	46	–	mA	Including load termination current for 5 pF loading at 156.25 MHz. See Figure 23 for termination
Current Consumption, Output Disabled without Termination	Idd_od_nt	–	48	–	mA	Excluding load termination current. Driver output is at logic-high voltage levels.
Current Consumption, Output Disabled with Termination	Idd_od_wt	–	48	–	mA	Including load termination current for 5 pF loading at 156.25 MHz. See Figure 23 for termination. Driver output is at logic-high voltage levels.
Output Characteristics						
Output High Voltage	VOH	0.8	0.9	1.15	V	See Figure 4
Output Low Voltage	VOL	-0.3	0	0.1	V	See Figure 4
Output Differential Voltage Swing	V_Swing	1.55	1.65	1.9	V	See Figure 5
Rise/Fall Time	Tr, Tf	–	520	–	ps	Measured with 2 pF capacitive loading to GND, 20% to 80%. See Figure 5
Differential Asymmetry, peak-peak	V_da	–	550	–	mV	See Figure 8
Differential Skew, peak	V_ds	–	\pm 30	–	ps	See Figure 9
Overshoot Voltage, peak	V_ov	–	10	–	%	Measured as percent of V_Swing; see Figure 10
Power Supply Noise Immunity						
Power Supply-Induced Jitter Sensitivity ^[2]	PSJS	–	0.01	–	ps/mV	Power supply ripple from 1 kHz to 20 MHz
Power Supply-Induced Phase Noise	PSPN	–	-80	–	dBc	156.25 MHz, 50 mV peak-peak ripple on VDD

Note:

- Terminology chosen for clarity; referred to historically as power-supply noise rejection (PSNR).

Table 13. Absolute Maximum Ratings

Attempted operation outside the absolute maximum ratings may cause permanent damage to the part.
Actual performance of the IC is only guaranteed within the operational specifications, not at absolute maximum ratings.

Parameter	Test Conditions	Min.	Max.	Unit
Continuous Power Supply Voltage Range (Vdd)		-0.5	4.0	V
Input Voltage, Maximum	Any input pin	–	Vdd + 0.3	V
Input Voltage, Minimum	Any input pin	-0.3	–	V
Storage Temperature		-65	150	°C
Maximum Junction Temperature		–	130	°C
Soldering Temperature (follow standard Pb-free soldering guidelines)		–	260	°C

Table 14. Thermal Considerations^[3]

Package	θ_{JA} , 4 Layer Board (°C/W)	θ_{JC} , Bottom (°C/W)
3225, 6-pin	TBD	TBD

Notes:

3. Refer to JESD51 for θ_{JA} and θ_{JC} definitions, and reference layout used to determine the θ_{JA} and θ_{JC} values in the above table.

Table 15. Maximum Operating Junction Temperature^[4]

Max Operating Temperature (ambient)	Maximum Operating Junction Temperature
70°C	TBD
85°C	TBD
95°C	TBD
105°C	TBD

Notes:

4. Datasheet specifications are not guaranteed if junction temperature exceeds the maximum operating junction temperature.

Table 16. Environmental Compliance

Parameter	Test Conditions	Value	Unit
Mechanical Shock Resistance	MIL-STD-883F, Method 2002	10,000	g
Mechanical Vibration Resistance	MIL-STD-883F, Method 2007	70	g
Soldering Temperature (follow standard Pb free soldering guidelines)	MIL-STD-883F, Method 2003	260	°C
Moisture Sensitivity Level	MSL1 @ 260°C		
Electrostatic Discharge (HBM)	HBM, JESD22-A114	2,000	V
Charge-Device Model ESD Protection	JESD220C101	750	V
Latch-up Tolerance	JESD78 Compliant		

Pin Description

Table 17. Pin Description

Pin	Map	Functionality	
1	OE/NF	Output Enable (OE)	H ^[5] Specified frequency output L: OUTP (OUTN) held at logic high (low)
		No Function (NF)	H or L or Open: No effect on output frequency or other device functions.
2	NF	No Function	H or L or Open: No effect on output frequency or other device functions
3	GND	Power	VDD Power Supply Ground
4	OUTP	Output	Oscillator output
5	OUTN	Output	Complementary oscillator output
6	VDD	Power	Power supply voltage ^[6]

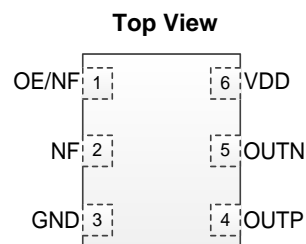


Figure 3. Pin Assignments

Notes:

5. OE pin includes a 120 k Ω internal pull-up resistor to VDD when active high, and a 120 k Ω internal pull-down resistor to GND when active low. In noisy environments, OE pin that is active high or active low are recommended to include an external pull-up or pull-down resistor, respectively, of 10 k Ω when the pin is not externally driven.
6. A capacitor of value 0.1 μ F or higher between VDD and GND pins is required.

FlexSwing Configurations

A FlexSwing output-driver performs like LVPECL but provides independent control of voltage swing and DC offset voltage levels. This simplifies interfacing with chipsets having non-standard input voltage requirements

and can eliminate all external source-bias resistors. FlexSwing supports power supply voltages from 1.71 V to 3.63 V, and the programmable VOH and VOL levels may be referenced to the voltage on either VDD or GND pins.

Table 18. FlexSwing 2-digit Order Codes specifying VHn and VLn referenced to voltage on VDD pin

Order Code V_Swing (V)			VLn																					
			A	B	C	D	E	F	G	H	J	K	L	M	N	P	Q	R	S	T	U	V	W	X
			Vdd-2.35V	Vdd-2.30V	Vdd-2.25V	Vdd-2.20V	Vdd-2.15V	Vdd-2.10V	Vdd-2.05V	Vdd-2.00V	Vdd-1.95V	Vdd-1.90V	Vdd-1.85V	Vdd-1.80V	Vdd-1.75V	Vdd-1.70V	Vdd-1.65V	Vdd-1.60V	Vdd-1.55V	Vdd-1.50V	Vdd-1.45V	Vdd-1.40V	Vdd-1.35V	Vdd-1.30V
VHn	A	Vdd-0.80V	Supply Voltage				Available Colors									AP	AQ	AR	AS	AT	AU	AV	AW	AX
	B	Vdd-0.85V	1.8V±5%				Not Supported								BN	BP	BQ	BR	BS	BT	BU	BV	BW	BX
	C	Vdd-0.90V	1.71V to 3.63V				Not Supported								CM	CN	CP	CQ	CR	CS	CT	CU	CV	CW
	D	Vdd-0.95V	2.5V±10%				Blue								DM	DN	DP	DQ	DR	DS	DT	DU	DV	DW
	E	Vdd-1.00V	3.3V±10%				Blue Red								EL	EM	EN	EP	EQ	ER	ES	ET	EU	
	F	Vdd-1.05V	2.25V to 3.63V				Blue								FL	FM	FN	FP	FQ	FR	FS	FT	FU	
	G	Vdd-1.10V													GM	GN	GP	GQ	GR	GS	GT	GU	GV	
	H	Vdd-1.15V													HL	HM	HN	HP	HQ	HR	HS	HT	HU	
	J	Vdd-1.20V													JL	JM	JN	JP	JQ	JR	JS	JT	JU	
	K	Vdd-1.25V													KL	KM	KN	KP	KQ	KR	KS	KT	KU	
	L	Vdd-1.30V													LM	LN	LP	LQ	LR	LS	LT	LU		
	M	Vdd-1.35V													MM	MN	MP	MQ	MR	MS	MT	MU		
	N	Vdd-1.40V													NN	NP	NQ	NR	NS	NT				
	P	Vdd-1.45V													PN	PP	PQ	PR	PS					
	Q	Vdd-1.50V													PM	PN	PQ	PR	PS					
	R	Vdd-1.55V													PM	PN	PN	PN	PN					
	S	Vdd-1.60V													PN	PN	PN	PN	PN					
	T	Vdd-1.65V													PN	PN	PN	PN	PN					
	U	Vdd-1.70V													PN	PN	PN	PN	PN					
	V	Vdd-1.75V													PN	PN	PN	PN	PN					
	W	Vdd-1.80V													PN	PN	PN	PN	PN					

The above table identifies supported combinations of nominal VOH (i.e. VHn) and nominal VOL (i.e. VLn) in colored boxes. The two-character code in each box corresponds to the VHn and VLn codes specified in the 2nd column and 2nd row in the table, respectively. The number in each box indicates the nominal differential swing (i.e. VHn – VLn).

For example, order code “FS” selects VHn code “F” (i.e. Vdd-1.05 V) and VLn code “S” (i.e. Vdd-1.55 V) corresponding to a V_Swing of 1 V peak-peak, which may be used for supply voltages of 2.5 V ±10%, 3.3 V ±10% or

(2.25 V to 3.63 V). Alternatively, an order code of “GS” corresponds to a VHn code “G” (i.e. Vdd-1.10 V) and a VLn order code “S” (e.g. Vdd-1.55 V) corresponding to a V_Swing of 0.9 V peak-peak, which may be used for a supply voltage of 3.3 V ±10%.

Order Code V_Swing (V)		VLn																																																		
		A	B	C	D	E	F	G	H	J	K	L	M	N	P	Q	R	S	T	U	V	W	X	Y	Z	1	2	3	4	5																						
		0.30V	0.35V	0.40V	0.45V	0.50V	0.55V	0.60V	0.65V	0.70V	0.75V	0.80V	0.85V	0.90V	0.95V	1.00V	1.05V	1.10V	1.15V	1.20V	1.25V	1.30V	1.35V	1.40V	1.45V	1.50V	1.55V	1.60V	1.65V	1.70V																						
VHn	A	2.50V																												A3	A4	A5																				
	B	2.45V																											B2	B3	B4	B5																				
	C	2.40V																											C1	C2	C3	C4	C5																			
	D	2.35V																											DZ	D1	D2	D3	D4	D5																		
	E	2.30V																											EY	EZ	E1	E2	E3	E4	E5																	
	F	2.25V																											FX	FY	FZ	F1	F2	F3	F4	F5																
	G	2.20V																											GW	GX	GY	GZ	G1	G2	G3	G4	G5															
	H	2.15V																												HV	HW	HX	HY	HZ	H1	H2	H3	H4	H5													
	J	2.10V																												JU	JV	JW	JX	JY	JZ	J1	J2	J3	J4	J5												
	K	2.05V																													KT	KU	KV	KW	KX	KY	KZ	K1	K2	K3	K4	K5										
	L	2.00V																													LS	LT	LU	LV	LW	LX	LY	LZ	L1	L2	L3	L4	L5									
	M	1.95V																														MR	MS	MT	MU	MV	MW	MX	MY	MZ	M1	M2	M3	M4	M5							
	N	1.90V																														NQ	NR	NS	NT	NU	NV	NW	NX	NY	NZ	N1	N2	N3	N4	N5						
	P	1.85V																														PP	PQ	PR	PS	PT	PU	PV	PW	PX	PY	PZ	P1	P2	P3	P4	P5					
	Q	1.80V																														QN	QP	QQ	QR	QS	QT	QU	QV	QW	QX	QY	QZ	Q1	Q2	Q3	Q4	Q5				
	R	1.75V																															RM	RN	RP	RQ	RR	RS	RT	RU	RV	RW	RX	RY	RZ	R1	R2	R3	R4	R5		
	S	1.70V																															SL	SM	SN	SP	SQ	SR	SS	ST	SU	SV	SW	SX	SY	SZ	S1	S2	S3	S4	S5	
	T	1.65V																															TK	TL	TM	TN	TP	TQ	TR	TS	TT	TU	TV	TW	TX	TY	TZ	T1	T2	T3	T4	T5

Waveform Diagrams

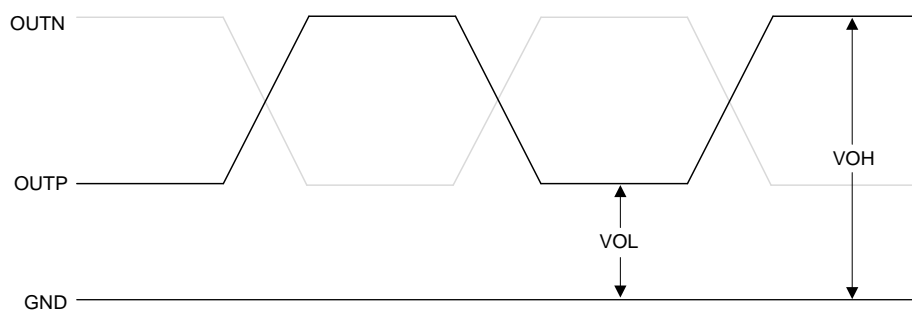


Figure 4. LVPECL, HCSL, Low-Power HCSL, and FlexSwing Voltage Levels per Differential Pin

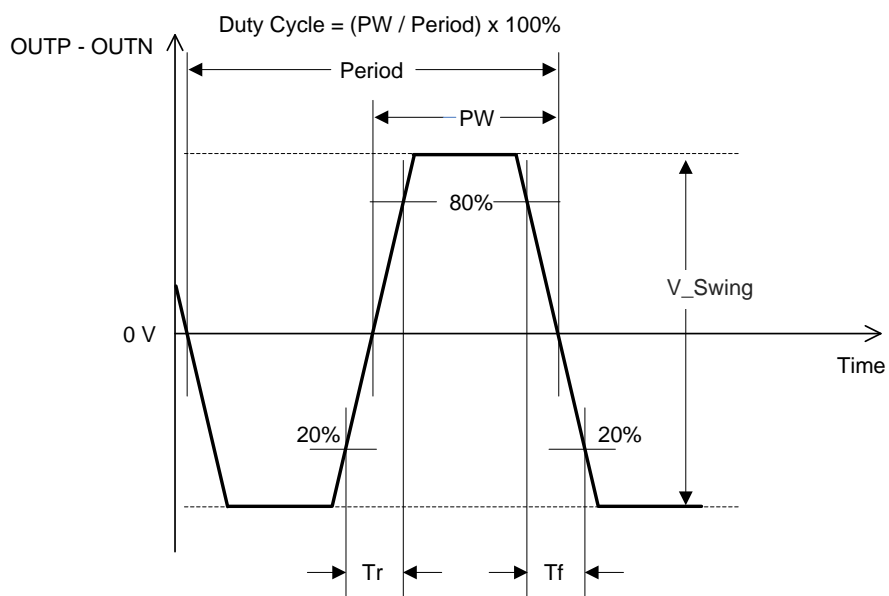


Figure 5. LVPECL, HCSL, Low-Power HCSL, and FlexSwing Voltage Levels Across Differential Pair

Waveform Diagrams (continued)

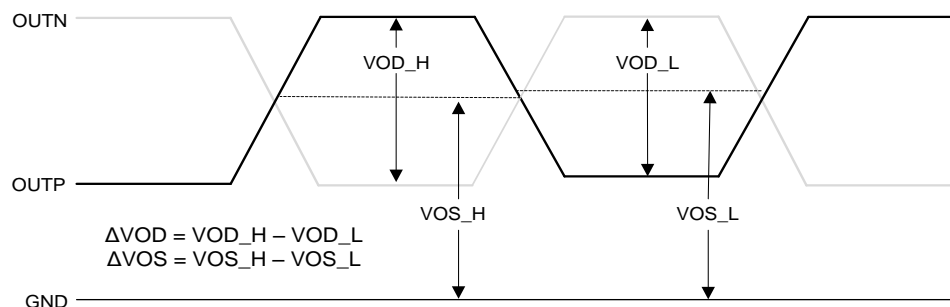


Figure 6. LVDS Voltage Levels per Differential Pin

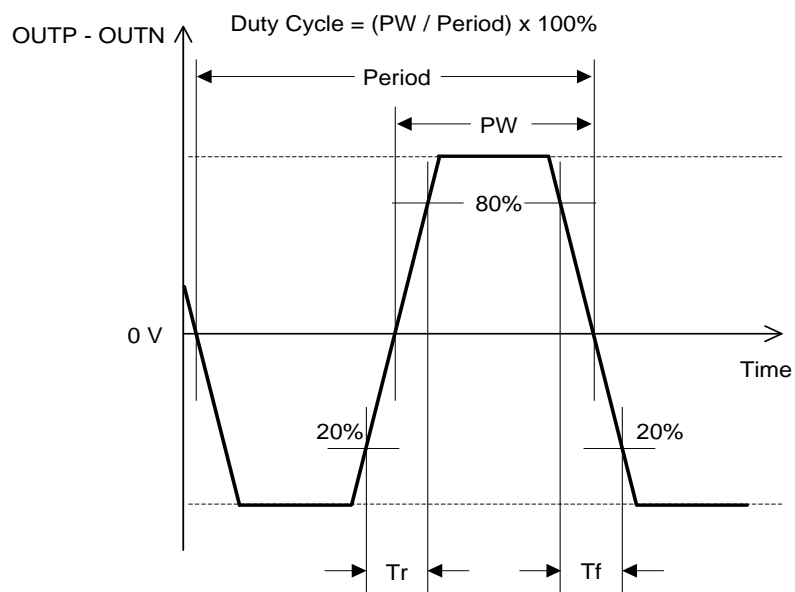


Figure 7. LVDS Differential Waveform

Waveform Diagrams (continued)

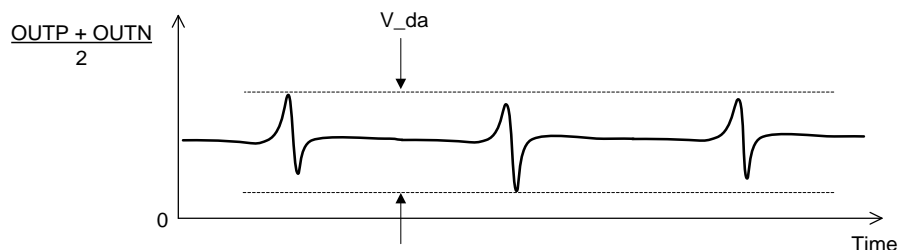


Figure 8. Differential Asymmetry (V_{da})

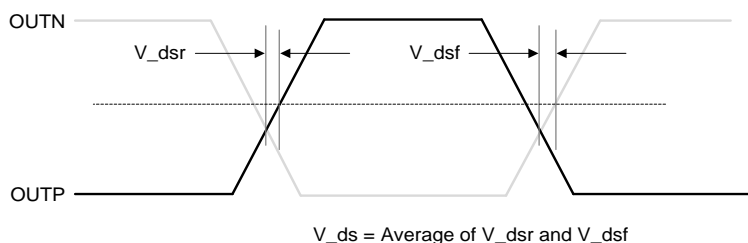


Figure 9. Differential Skew (V_{ds}) is measured as the Time between the Average Voltage Level and Crossing Voltage

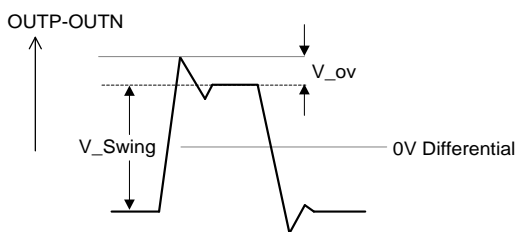


Figure 10. Overshoot Voltage (V_{ov}) for LVPECL, FlexSwing, HCSL, Low-power HCSL

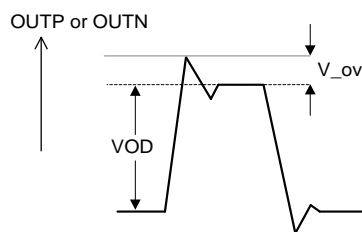


Figure 11. Overshoot Voltage (V_{ov}) for LVDS Output

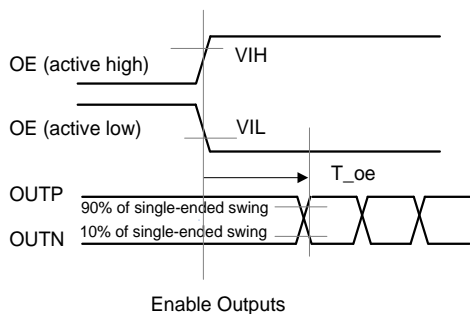


Figure 12. OE Pin Enable Timing (T_{oe})

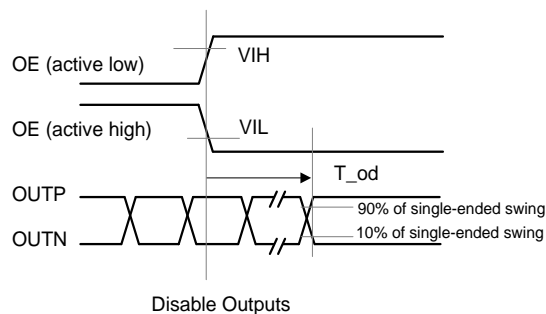


Figure 13. OE Pin Disable Timing (T_{od})

Termination Diagrams

LVPECL and FlexSwing Termination

The SiT9375 output drivers include special features for supporting low-load current without sacrificing signal integrity via simple terminations as shown in Figure 15 and Figure 17. This allows very low power consumption compared to traditional LVPECL drivers. The FlexSwing

and LVPECL outputs are voltage-mode drivers. Use the table and figures below to select a termination circuit for the desired supply voltage. The table also provides LVPECL current consumption (I_{load}) into the load termination.

Table 20. Termination Options for LVPECL and FlexSwing Signaling

Signaling	Supply Voltage, V _{dd}	Termination Options					
		Figure 14	Figure 15	Figure 16	Figure 17	Figure 18	Figure 19
LVPECL referenced to V _{dd}	2.5 V $\pm 10\%$, 3.3 V $\pm 10\%$, 2.25 V to 3.63 V	OK to use $I_{load} = 40$ mA with 100 Ω near-end bias resistor	Do Not Use	OK to use $I_{load} = 28$ mA	OK to use	OK to use $I_{load} = 28$ mA	Do Not Use
FlexSwing referenced to V _{dd}			OK to use (See Figure 15 for frequency ranges and voltage swings)	OK to use ⁷	OK to use	OK to use	Do Not Use
FlexSwing referenced to Gnd	1.71 V to 3.63 V	OK to use ⁷		Do Not Use	OK to use	Do Not Use	Do Not Use
	1.8 V $\pm 5\%$			Do Not Use	OK to use	Do Not Use	OK to use

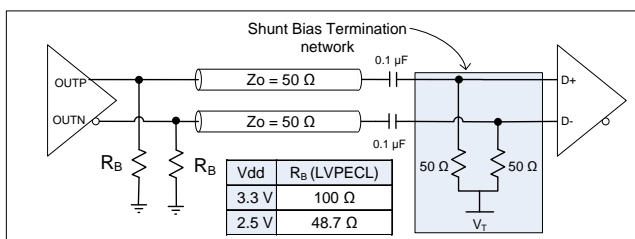


Figure 14. Recommended LVPECL and FlexSwing⁸ Termination when AC-coupled

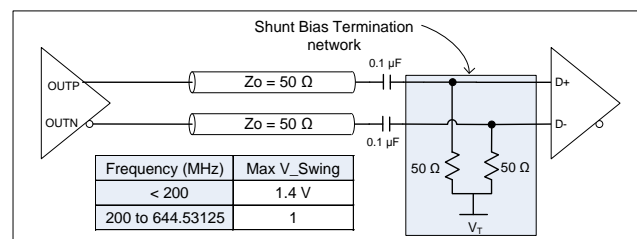


Figure 15. Recommended FlexSwing Termination when AC-coupled

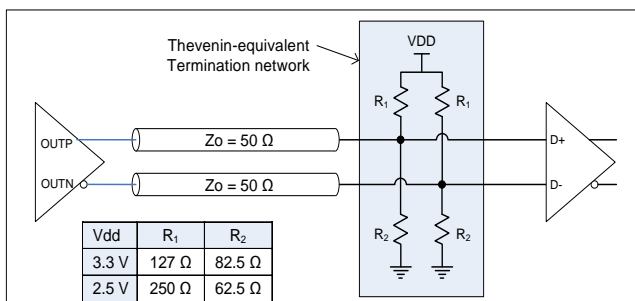


Figure 16. LVPECL and FlexSwing DC-coupled Load Termination with Thevenin Equivalent Network

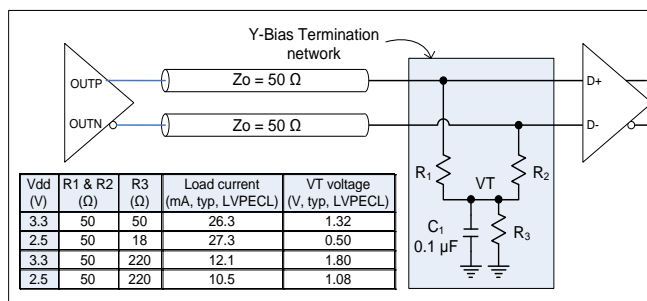


Figure 17. LVPECL and FlexSwing with DC-coupled Parallel Shunt Load Termination

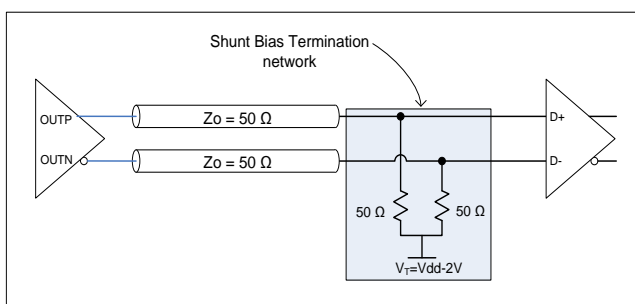


Figure 18. LVPECL and FlexSwing with Y-Bias Termination

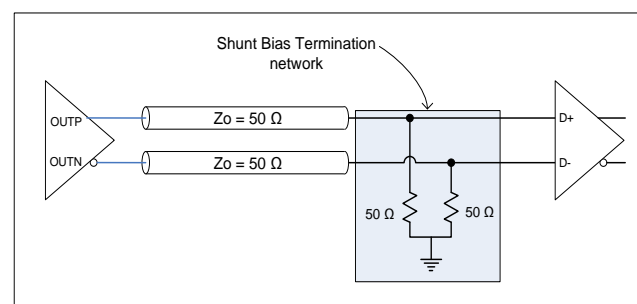


Figure 19. FlexSwing Termination – Only for use with Supply Voltage Order Code “18”

Termination Diagrams (continued)

LVDS, Supply Voltage: 1.8 V \pm 5%, 2.5 V \pm 10%, 3.3 V \pm 10%, 2.25 V to 3.63 V, 1.71 V to 3.63 V

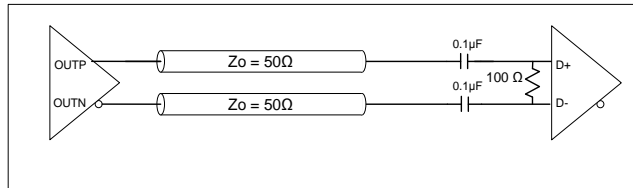


Figure 20. LVDS AC Termination

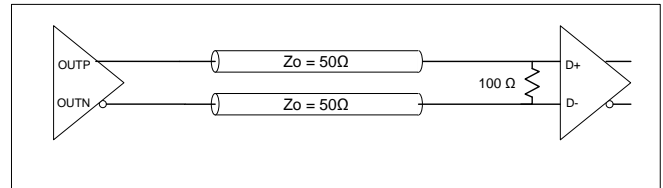


Figure 21. LVDS DC Termination at the Load

HCSL, Supply Voltage: 1.8 V \pm 5%, 2.5 V \pm 10%, 3.3 V \pm 10%, 2.25 V to 3.63 V, 1.71 V to 3.63 V

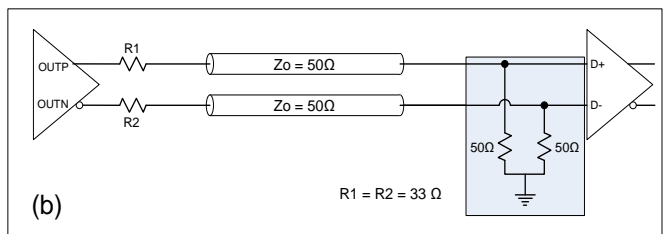
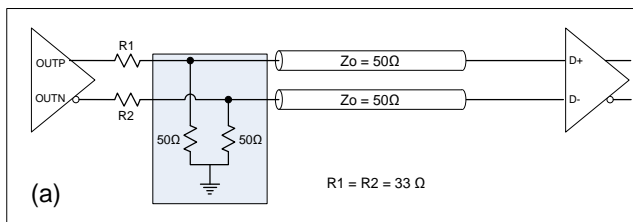


Figure 22. (a) HCSL Source Termination and (b) HCSL Load Termination

Low-power HCSL, Supply Voltage: 1.8 V \pm 5%, 2.5 V \pm 10%, 3.3 V \pm 10%, 2.25 V to 3.63 V, 1.71 V to 3.63 V

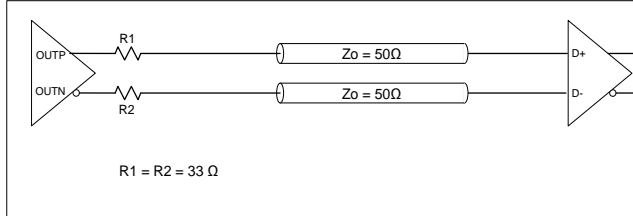
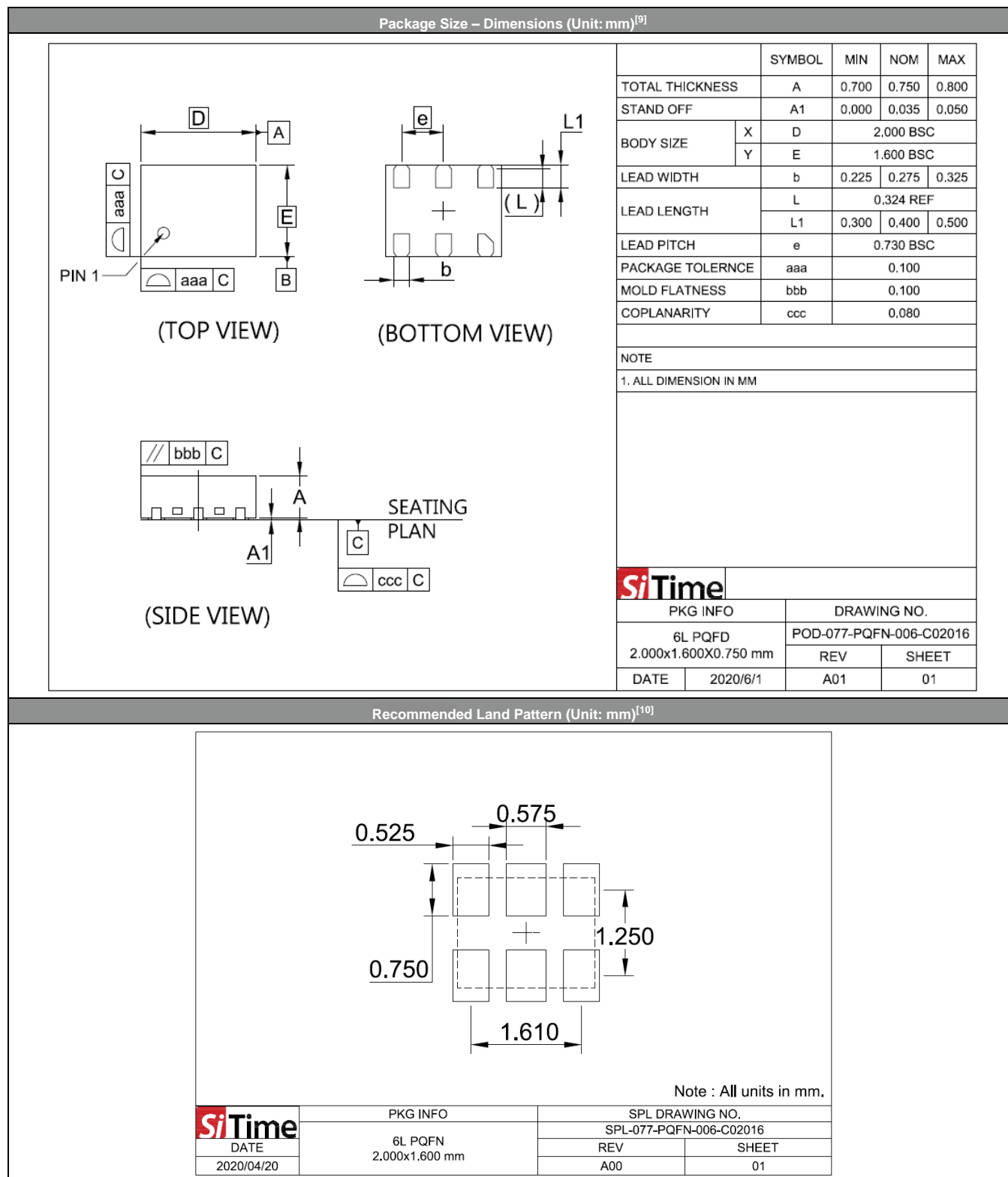


Figure 23. Low-power HCSL Termination

Notes:

7. [Contact SiTime](#) for optimum R1 and R2 values for FlexSwing options.
8. [Contact SiTime](#) for optimum Rs values for FlexSwing options.

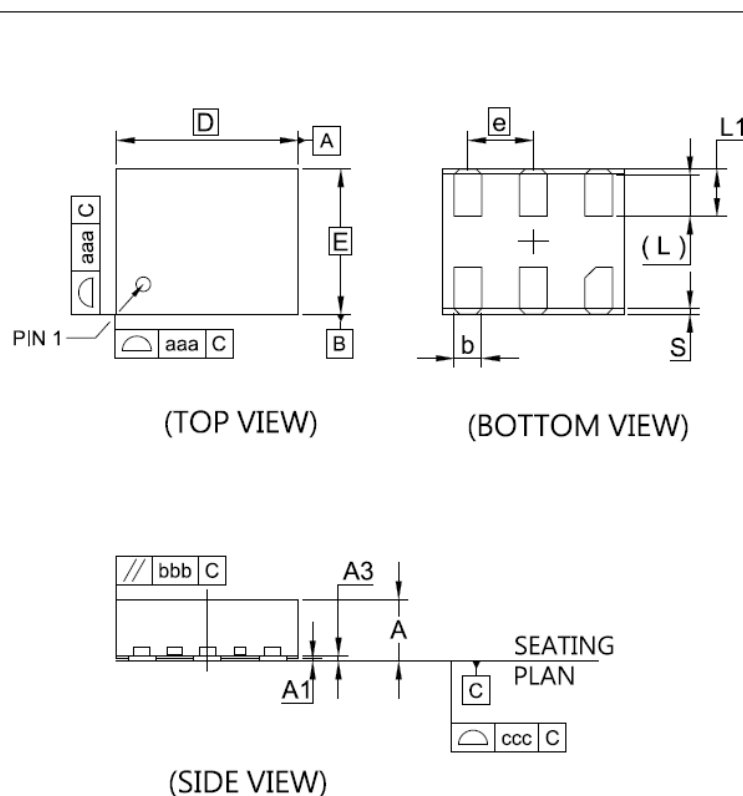
Dimensions and Patterns — 2.0 x 1.6 mm x mm



Notes:

- Top Marking: Y denotes manufacturing origin and XXXX denotes manufacturing lot number. The value of "Y" will depend on the assembly location of the device.
- A capacitor of value 0.1 μF or higher between VDD and GND is required. An additional 10 μF capacitor between VDD and GND is required for the best phase jitter performance.

Dimensions and Patterns — 2.5 x 2.0 mm x mm

Package Size – Dimensions (Unit: mm)^[9]

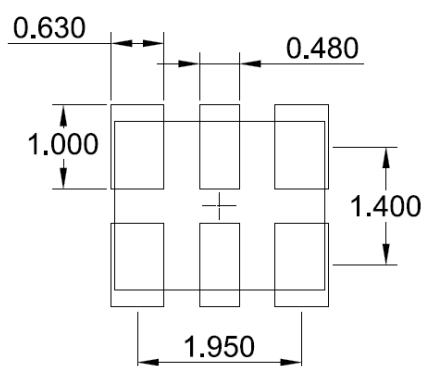
	SYMBOL	MIN	NOM	MAX
TOTAL THICKNESS	A	0.800	0.850	0.900
STAND OFF	A1	0.000	0.035	0.050
BODY SIZE	X	D	2.500 BSC	
	Y	E	2.000 BSC	
LEAD WIDTH	b	0.330	0.380	0.430
LEAD LENGTH	L	0.572 REF		
	L1	0.550	0.650	0.750
LEAD PITCH	e	0.900 BSC		
PACKAGE TOLERANCE	aaa	0.100		
MOLD FLATNESS	bbb	0.100		
COPLANARITY	ccc	0.080		
HALF CUT WIDTH	R	0.075	---	---
HALF CUT DEPTH	A3	---	---	0.075

NOTE

1. ALL DIMENSION IN MM



PKG INFO		DRAWING NO.	
6L PQFD 2.500x2.000X0.850 mm		POD-078-PQFW-006-C02520	
DATE		REV	SHEET
2020/6/1		A01	01

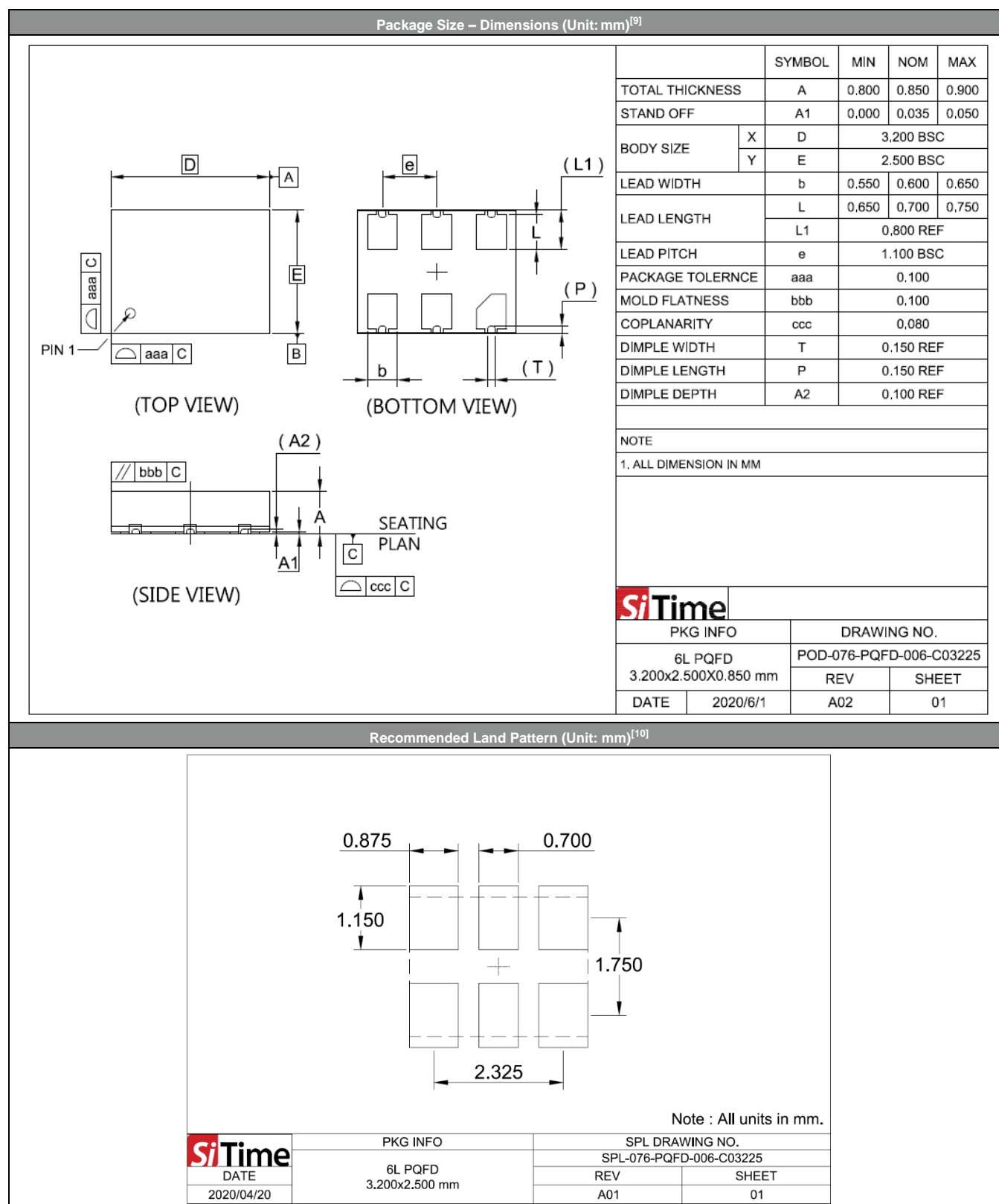
Recommended Land Pattern (Unit: mm)^[10]

Note : All units in mm.



PKG INFO		SPL DRAWING NO.	
DATE		SPL-078-PQFW-006-C02520	
2020/04/20		REV	SHEET
		A00	01

Dimensions and Patterns — 3.2 x 2.0 mm x mm



Additional Information

Table 21. Additional Information

Document	Description	Download Link
ECCN #: EAR99	Five character designation used on the commerce Control List (CCL) to identify dual use items for export control purposes.	—
HTS Classification Code: 8542.39.0000	A Harmonized Tariff Schedule (HTS) code developed by the World Customs Organization to classify/define internationally traded goods.	—
Manufacturing Notes	Tape & Reel dimension, reflow profile and other manufacturing related info	https://www.sitime.com/support/resource-library?filter=531
Termination Techniques	Termination design recommendations	http://www.sitime.com/support/application-notes
Layout Techniques	Layout recommendations	http://www.sitime.com/support/application-notes
Evaluation Boards	SiT6760EB	TBD

Revision History

Table 22. Revision History

Revision	Release Date	Change Summary
0.5	May 22, 2020	Advanced datasheet
0.51	Jun 1, 2020	Formatting changes Updated package drawings
0.52	Jul 28, 2020	Extended frequency to 644.53125 MHz
0.53	Aug 2, 2020	Modified Termination Diagrams section
0.54	Sep 23, 2020	Modified LVPECL, FlexSwing, LVDS current consumption specifications Modified phase jitter specification Added FlexSwing order codes Added 250u T&R order code Changed rev table date format

SiTime Corporation, 5451 Patrick Henry Drive, Santa Clara, CA 95054, USA | Phone: +1-408-328-4400 | Fax: +1-408-328-4439

© SiTime Corporation 2020. The information contained herein is subject to change at any time without notice. SiTime assumes no responsibility or liability for any loss, damage or defect of a Product which is caused in whole or in part by (i) use of any circuitry other than circuitry embodied in a SiTime product, (ii) misuse or abuse including static discharge, neglect or accident, (iii) unauthorized modification or repairs which have been soldered or altered during assembly and are not capable of being tested by SiTime under its normal test conditions, or (iv) improper installation, storage, handling, warehousing or transportation, or (v) being subjected to unusual physical, thermal, or electrical stress.

Disclaimer: SiTime makes no warranty of any kind, express or implied, with regard to this material, and specifically disclaims any and all express or implied warranties, either in fact or by operation of law, statutory or otherwise, including the implied warranties of merchantability and fitness for use or a particular purpose, and any implied warranty arising from course of dealing or usage of trade, as well as any common-law duties relating to accuracy or lack of negligence, with respect to this material, any SiTime product and any product documentation. Products sold by SiTime are not suitable or intended to be used in a life support application or component, to operate nuclear facilities, or in other mission critical applications where human life may be involved or at stake. All sales are made conditioned upon compliance with the critical uses policy set forth below.

CRITICAL USE EXCLUSION POLICY

BUYER AGREES NOT TO USE SITIME'S PRODUCTS FOR ANY APPLICATION OR IN ANY COMPONENTS USED IN LIFE SUPPORT DEVICES OR TO OPERATE NUCLEAR FACILITIES OR FOR USE IN OTHER MISSION-CRITICAL APPLICATIONS OR COMPONENTS WHERE HUMAN LIFE OR PROPERTY MAY BE AT STAKE.

SiTime owns all rights, title and interest to the intellectual property related to SiTime's products, including any software, firmware, copyright, patent, or trademark. The sale of SiTime products does not convey or imply any license under patent or other rights. SiTime retains the copyright and trademark rights in all documents, catalogs and plans supplied pursuant to or ancillary to the sale of products or services by SiTime. Unless otherwise agreed to in writing by SiTime, any reproduction, modification, translation, compilation, or representation of this material shall be strictly prohibited.